SMD Common Mode Chokes

#### **ACM7060F Series**

### **FEATURES**

- Winding type realizes small size and low profile
- Prevention of common mode noise at high frequency
- Excellent solderability
- Operating temperature -40~+125 °C (Including self temperature rise)
- RoHS Compliant

#### **FEATURES**

- Power line noise countermeasure for electronic equipment (Notebook, server applications, Battery, etc.)
- Best for high current circuit such as car
- Wireless charging and power device design

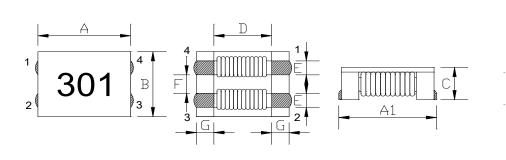
#### **Explanation of Part Number**

ACM 7060 F- 701 T40

1 2 3 4 5 6

- ▲ 1:Product Series:Wire Wound Common Mode Chokes
- ♦ 2:Dimensions:
- ♦ 3: Material Code: Ferrite
- 4:Common Mode Impedance(Ω)
- ♦ 5:Packing(Tape & Reel)
- ♦ 6:Rated Current:40=4.0A

## Shapes and Dimensions [Dimensions in mm]



A1: 7.5±0.5 mm

B: 6.0±0.5 mm

C: 3.8Max. mm

D: 3.5Typ. mm

E: 1.5±0.2 mm

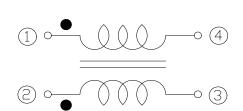
F: 1.5±0.2 mm

G: 1.75±0.2 mm

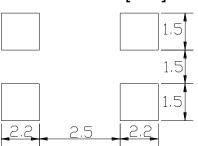
mm

A: 7.0±0.5

## Equivalent circuit



## Land Pattern: [mm]





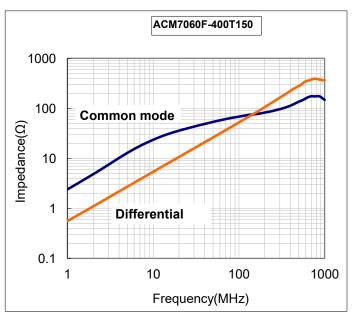
## **Electrical Characterisitics:**

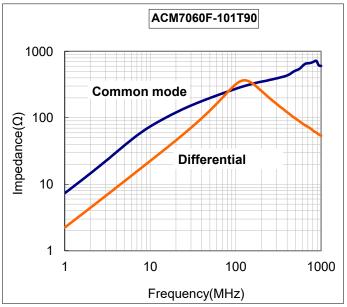
PT/NO.	Impedance(Ω)  at 100MHz		Resistance RDC(Ω) Max.(1 line)	Rated Current	Insulation Resistance	Rated Voltage (V)Max.
	Min.	Тур.		(A) Max.	(MΩ) Min.	( - )
ACM7060F-400T150	40	70	5m	15	10	125
ACM7060F-101T90	100	140	10m	9.0	10	125
ACM7060F-301T50	225	300	10m	5.0	10	125
ACM7060F-501T50	275	350	10m	5.0	10	125
ACM7060F-601T40	500	700	15m	4.0	10	125
ACM7060F-701T40	500	700	15m	4.0	10	125
ACM7060F-102T30	800	1020	17m	3.0	10	125
ACM7060F-132T25	910	1300	21m	2.5	10	125
ACM7060F-272T10	2000	2700	63m	1.0	10	125
ACM7060F-302T09	2500	3000	75m	0.9	10	125

Rated Current : Based on temperature rise ( $\triangle T$ : 40°C TYP.)

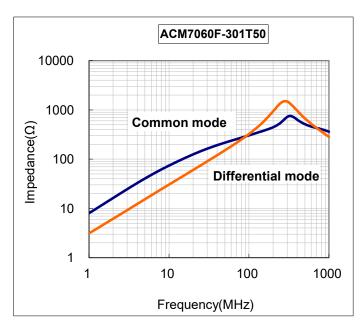
## TYPICAL ELECTRICAL CHARACTERISTICS

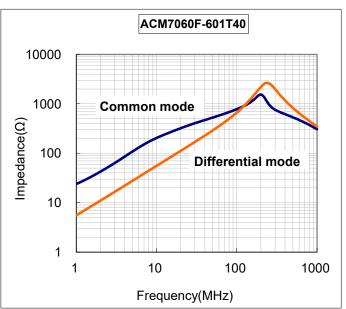
## Impedance VS. Frequency

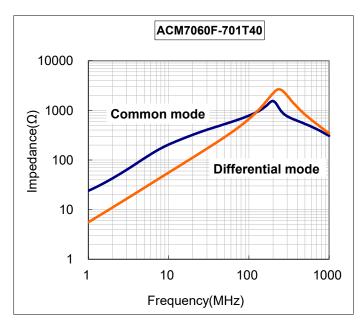


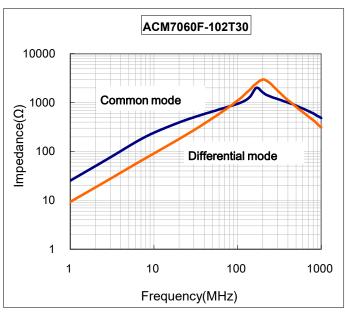


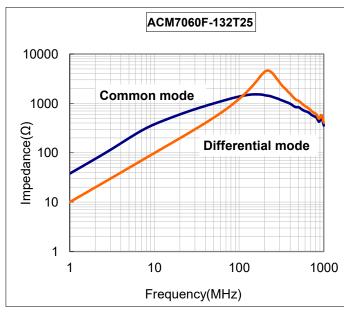


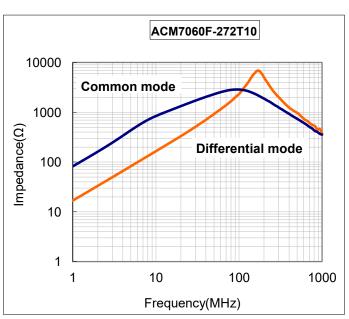




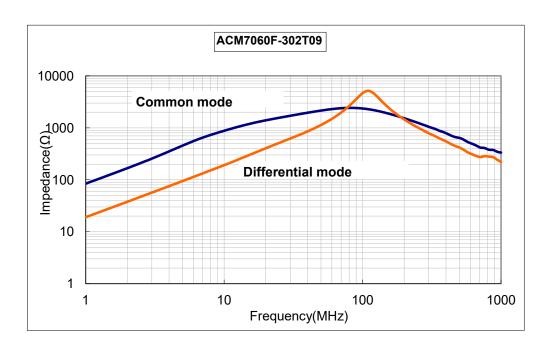








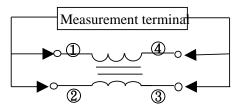




## **TEST EQUIPMENT**

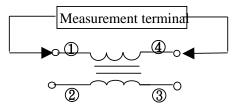
#### **Impedance**

Measured by using HP4291B RF Impedance Analyzer.



#### **DC** Resistance

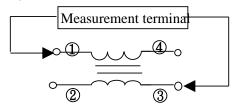
Measured by using Chroma 16502 milliohm meter.



#### **Insulation Resistance**

Measured by using Chroma 19073

Measurement voltage: 50v, Measurement time: 60 sec.





# **Reliability Test**

#### **MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS		
Solder ability	The product shall be connected to the test	Apply cream solder to the printed circuit board .		
	circuit board by the fillet (the height is 0.2mm).	Refer to clause 8 for Reflow profile.		
Resistance to	There shall be no damage or problems.	Temperature profile of reflow soldering		
Soldering heat		© 300 — soldering (Peak temperature 260±3°ℂ 10 sec)		
(reflow soldering)		9 g g g g g g g g g g g g g g g g g g g		
		Soldering  (Peak temperature 260±3°C 10 sec)  250  Example 200  Pre-heating  150  Slow cooling (Stored at room temperature)		
		g 150 Pre-heating Slow cooling		
		150 ~ 180°C (Stored at room temperature)		
		ο <sub>50</sub> –/		
		2 min   10   2 min. or more		
		k →   k → k		
		The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.		
		The specimen shall be stored at standard atmospheric		
		eric conditions for 1 hour, after which the measurement		
		shall be made.		
Terminal strength	The terminal electrode and the ferrite must	Solder a chip to test substrate , and then laterally apply		
	not damaged.	a load 9.8N in the arrow direction.		
		Printed circuit board		
Strength on PC board	The terminal electrode and the ferrite must	Solder a chip to test substrate and then apply a load.		
bending	not damaged.	10 20		
		Test board:FR4 100×40×1mm		
		R10 Fall speed:1mm/sec.		
		***		
		45 Dimensions in mm		
	Improduces Within 1999/ - £4h- 1-1/-	After the complex shall be relatived anti-the test start		
High	Impedance:Within±20% of the initial value. Insulation resistance and DC resistance on the	After the samples shall be soldered onto the test circuit		
temperature	specification(refer to clause 2-1) shall be met.	board,the test shall be done.  Measurement : After placing for 24 hours min.		
resistance	The terminal electrode and the ferrite must not	Temperature : +125±2°C		
	damaged.	Applied voltage : Rated voltage		
		Applied current : Rated current		
		Testing time : 500±12 hours		
		<u> </u>		



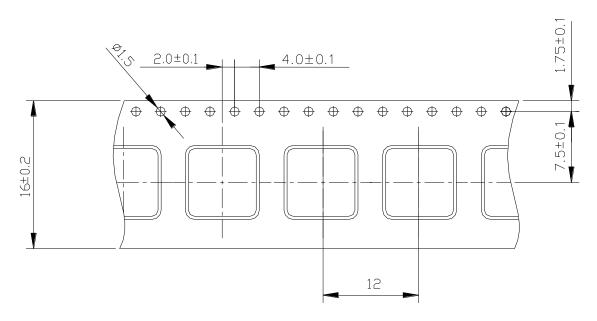
### **MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS
Humidity	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit
resistance	Insulation resistance and DC resistance on the	board,the test shall be done.
	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.
	The terminal electrode and the ferrite must not	Temperature : +60±2℃ , Humidity : 90 to 95 %RH
	damaged.	Applied voltage : Rated voltage
		Applied current : Rated current
		Testing time : 500±12 hours
Thermal shock	Impedance:Within±20% of the initial value. Insulation resistance and DC resistance on the specification(refer to clause 2-1) shall be met. The terminal electrode and the ferrite must not damaged.	1 cycle 30 min 30 sec 30 min.
Low	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test
temperature	Insulation resistance and DC resistance on the	circuit board,the test shall be done.
storage	specification(refer to clause 2-1) shall be met.	Measurement : After placing for 24 hours min.
_	The terminal electrode and the ferrite must	Temperature : -40±2℃
	not damaged.	Testing time : 500±12 hours
Vibration	Impedance:Within±20% of the initial value.	After the samples shall be soldered onto the test circuit
	Insulation resistance and DC resistance on	board,the test shall be done.
	the specification(refer to clause 2-1)	Frequency : 10 to 55 Hz
	shall be met.	Amplitude : 1.52 mm
	The terminal electrode and the ferrite must	Dimension and times : X ,Y and Z directions
	not damaged.	for 2 hours each.
Solderability	New solder More than 75%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated
		over the whole of the sample before hard, the sample shall
		then be preheated for about 2 minutes in a temperature
		of 130∼150℃ and after it has been immersed to a depth
		0.5mm below for 3±0.2 seconds fully in molten solder
		M705 with a temperature of 245±2℃. More than 75% of the
		electrode sections shall be couered
		with new solder smoothly when the sample is taken out
		of the solder bath.

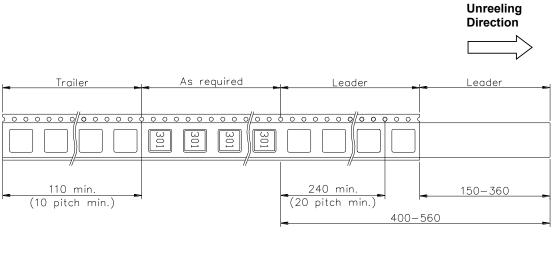


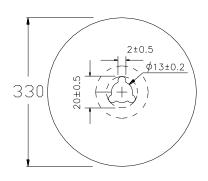
# **Packaging**

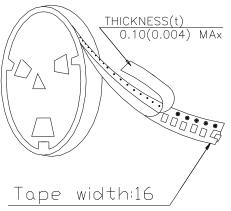
## **CARRIER TAPE DIMENSIONS (mm)**



## **TAPING DIMENSIONS (mm)**







# **Packing Quantity**

1500 pcs./reel